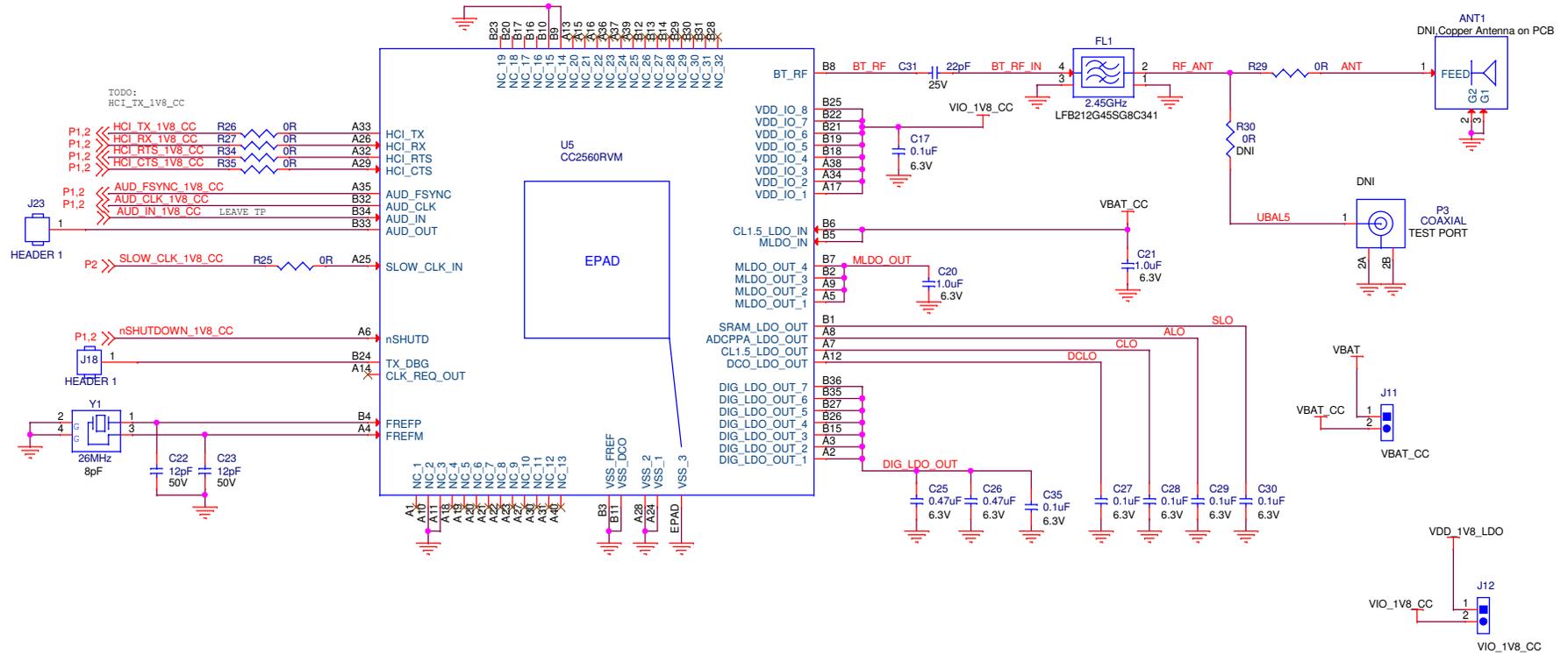


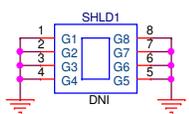
		Title BT-MSP-AUDSOURCE	
Designer Miguel Sanchez	Size B		EDGE No 6576620
Drawn By Zahid Haq	Date Monday, April 07, 2014		Rev 1.1
Layout Prashantha, Zahid			Page 1 of 4

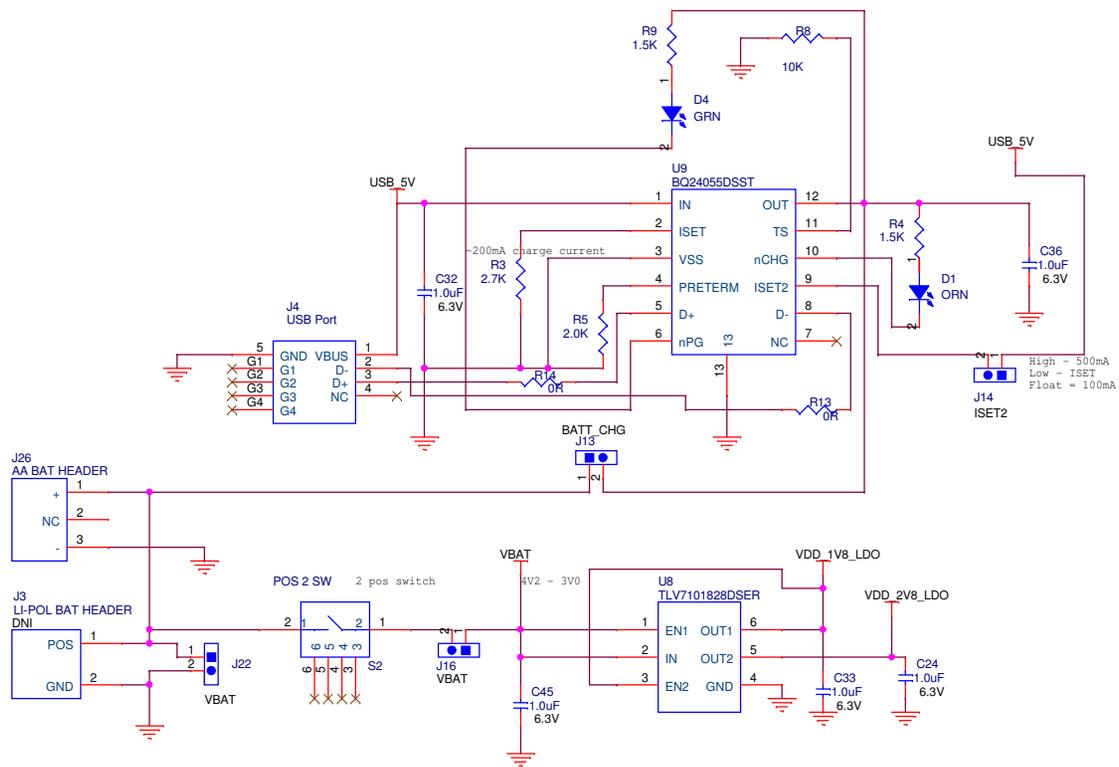
CC256x HCI Class 1.5 capable Bluetooth device



CC256xQFN

Title		
BT-MSP-AUDSOURCE		
Size B	EDGE No	6576620
Date		Friday, March 07, 2014
Rev		1.1
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POWER SUPPLY

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